

LTspice Model Comparator TOSHIBA TA75S393F

Model Information

Model An original macro model Call Name MDC_TA75S393F_LT

Pin Assign 1:IN(-) 2:VEE 3:IN(+) 4:OUT 5:VCC

File List Model Library MDC_TA75S393F_LT01.lib

Model Report MDC_TA75S393F_LT.pdf (this file)

Verified Simulator Version

Note

LTspice version XVII

References

The information which was used for modeling is as follow:

[Data Sheet]

Date/VersionProduct name2014-03-01TA75S393F

Company nameCharacteristicsToshiba CorporationICC,II,IIO,VIO, Response

Simulation Condition

This table shows the value of evaluated simulation condition that was not occurs any convergence problems in this area.

| Item | Condition | Unit |
|-------------|-----------|-------|
| Temperature | 25 | deg C |

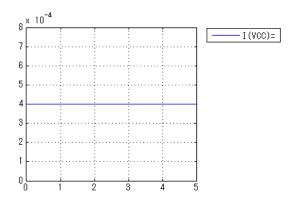


Simulation results are following.

Explanatory notes — : simulated

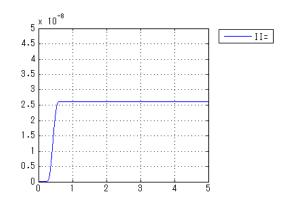
ICC

Temp. = 25deg C



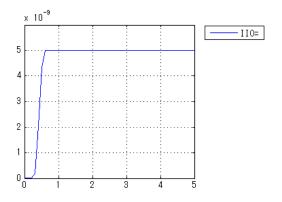
Ш

Temp. = 25deg C



IIO

Temp. = 25deg C

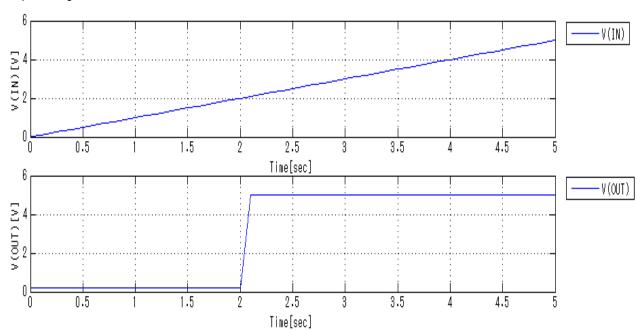




Simulation results are following. Explanatory notes — : simulated

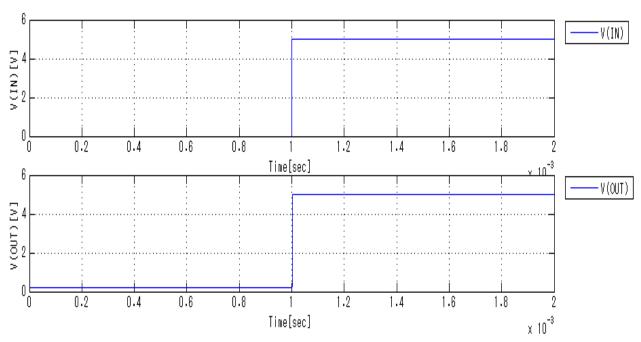
VIO

Temp. = 25deg C



Response

Temp. = 25deg C





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